

General Description

The Digital Blocks DB-I3C-BASIC-M-APB IP Core interfaces a microprocessor via the AMBA APB Bus to an I3C Bus, compliant to the MIPI I3C Basic v1.2 Improved Inter Integrated Circuit specification. I3C Basic serves as an upgrade path to the I2C standard.

The I3C is a two-wire bidirectional interface standard (SCL is Clock, SDA is Data) for transfer of bytes of information between two or more compliant I3C devices as well as legacy I2C Slave devices.

The DB-I3C-BASIC-M-APB is a Controller-only (Master-only) implementation – the Target role logic is removed for a smaller VLSI footprint – for applications in which the host processor owns the I3C bus. It drives the SCL clock and initiates all traffic: I3C SDR Broadcast & Direct Messages, the v1.2 High Data Rate modes HDR-DDR and HDR-BT including HDR-BT Multi-Lane, and legacy I2C messages to I2C Target devices sharing the bus. With a 12.5 MHz SCL the core reaches 12.5 Mbps in SDR, 25 Mbps in HDR-DDR and HDR-BT, and 50 / 100 Mbps in HDR-BT Multi-Lane x2 / x4.

In an ASIC / ASSP / FPGA integrated circuit the microprocessor is typically an ARM or RISC-V processor, but can be any embedded processor. Figure 1 depicts the system view of the DB-I3C-BASIC-M-APB IP Core embedded within an integrated circuit device with its microprocessor configuration.

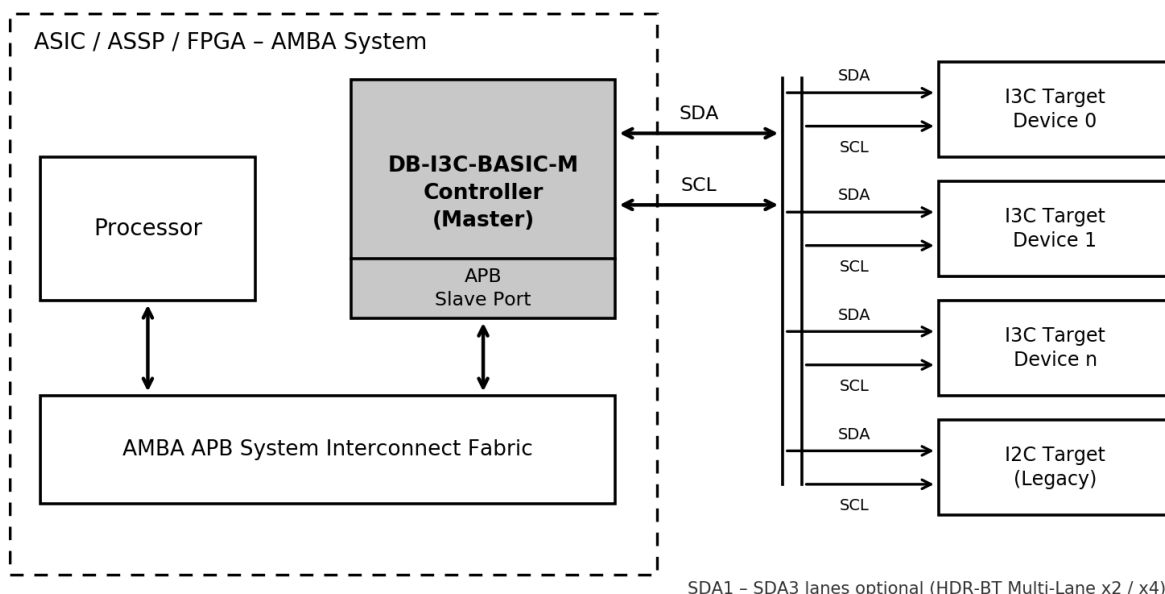


Figure 1: DB-I3C-BASIC-M-APB Controller System Diagram

Features

- I3C Controller (Master) – implements the Controller-only protocol for a smaller VLSI footprint, for applications requiring Controller-Transmitter and Controller-Receiver capability
- Supported I3C bus modes and data rates:
 - Single Data Rate (SDR) – up to 12.5 MHz SCL, 12.5 Mbps
 - HDR-DDR – 25 Mbps (2 bits per SCL period) at the same 12.5 MHz SCL
 - HDR-BT – 25 Mbps single lane
 - HDR-BT Multi-Lane – 50 Mbps (x2) / 100 Mbps (x4), build-time lane option
 - Legacy I2C – messages to legacy I2C Target devices sharing the bus, with count-word read length
- I3C communications support:

- I3C SDR Private Write / Read, Broadcast and Direct messages
- Complete frames – START, address header, message bytes, Repeated Start and STOP – are composed in software as sideband-tagged FIFO words and executed autonomously by hardware
- Any broadcast or direct CCC can be issued from the transmit queue without dedicated per-CCC logic
- HDR (High Data Rate) modes, MIPI I3C Basic v1.2:
 - HDR-DDR (§6.2): hardware ENTHDR0 entry, HDR Restart Pattern between messages of one frame, and HDR Exit Pattern – 20-bit words with preamble, PA1/PA0 parity and CRC-5
 - HDR-BT / Bulk Transport (§6.4): 7-byte Header Block, 32-byte Data Blocks with ragged Last block, CRC Block with CRC-16 (mandatory) or CRC-32 (optional), receiver-driven termination in both directions, and zero-length writes
 - HDR-BT Multi-Lane (§6.7, Coding 0 Compatible Mode): data and CRC blocks striped over 2 or 4 lanes; all bus management stays on SCL / SDA0 for interoperability with single-lane devices
 - ENDXFER CCC flow-control configuration: write ACK/NACK, write early termination, and CRC-after-read-abort
 - MLANE CCC (0x2D / 0x9D) generation: Get-ML-Caps, lane-format Set / Get, and ML reset
 - Error detection: preamble / framing, HDR-DDR parity and CRC-5, HDR-BT header parity, CRC-16 / CRC-32 and the Transition_Verify handshake – reported per message and in sticky HDR status registers with error counters
 - HDR modes are a build-time option (HDR_EN); with HDR removed the core is SDR-only and remains HDR-tolerant
- I3C compliant features:
 - I3C Characteristics Registers (BCR / DCR)
 - Common Command Code (CCC) generation – broadcast ENEC, DISEC, RSTDAA, ENTDAAs, ENTASx, SETMWL, SETMRL, ENDXFER, RSTACT, ENTHDRx, MLANE; direct SETNEWDA, SETMWL / GETMWL, SETMRL / GETMRL, GETBCR, GETDCR, GETPID, GETSTATUS, GETCAPS, ENDXFER, RSTACT, MLANE
 - Dynamic Address Assignment – ENTDAAs sequencer with a 4-entry dynamic-address cache and null-data flow for devices that do not respond
 - In-Band Interrupt (IBI) servicing, with payload
 - Hot-Join acceptance
 - Target Reset Pattern generation, with the RSTACT reset-action CCC
 - Multi-drop capability
 - I3C error processing
- Programmable SCL clock generation – independent push-pull and open-drain clock dividers, so the open-drain address header and the push-pull data phases each meet their I3C timing
- Parameterized FIFO memory for off-loading the I3C transfers from the processor:
 - The I3C Controller independently executes the I3C message with bytes of information buffered to and from a FIFO
 - Separate TX and RX FIFOs, parameterizable in depth (256 bytes by default) and width
- System-level features & integration capabilities:
 - CPU interface to Control / Status Registers and the parameterized FIFO, with support for APB / AHB / AXI / AXI4-Lite / Avalon SoC interconnect fabrics (APB and AXI4-Lite delivered from the same RTL tree)
 - Internal interrupt controller (single interrupt to the embedded processor, with per-source mask and status registers)
 - Optional: DMA transfer between the I3C Bus and memory (SDRAM / SRAM / FLASH)
 - Build-time configuration: HDR_EN (HDR modes), Multi-Lane x1 / x2 / x4, FIFO depth, and CPU bus interface
- Fully-synchronous, synthesizable SystemVerilog RTL core with no gated clocks and no internal tri-states, for easy integration into FPGA or ASIC design flows. The SDR logic is rising-edge clocked; the HDR engines additionally use the falling SCL edge for dual-edge data (constraints supplied).
- Low power RTL design
- Compliance with I3C, I2C, and AMBA specifications:
 - MIPI Alliance – Specification for I3C Basic (Improved Inter Integrated Circuit), Version 1.2, public edition with errata 01
 - Verified against the MIPI Alliance I3C Conformance Test Suite (CTS) v1.2, public edition
 - Philips / NXP – The I2C-Bus Specification, Version 2.1, January 2000, and UM10204 Rev 6, 4 April 2014
 - AMBA APB

Pin Description

In addition to the AMBA APB Bus interface, which includes the input clock and reset and the output interrupt, the I3C bus interface signals are listed in Table 1. The I3C pads are driven with the Digital Blocks open-drain / push-pull convention: an *_en output pulled low drives the line low, and the matching *_en_active_drv output selects push-pull drive for the I3C high phases. A bi-directional pad may be used for SDA / SCL by combining the enable and data outputs.

Name	Type	Description
AMBA APB Slave Interface		
db_i3c_slv_pclk	Input	APB clock (PCLK)
db_i3c_slv_presetn	Input	APB reset, active low (PRESETn)
db_i3c_slv_psel	Input	APB select
db_i3c_slv_penable	Input	APB enable
db_i3c_slv_pwrite	Input	APB write (1) / read (0)
db_i3c_slv_paddr[31:0]	Input	APB address
db_i3c_slv_pwdata[31:0]	Input	APB write data
db_i3c_slv_prdata[31:0]	Output	APB read data
intr	Output	Interrupt to the microprocessor
I3C Bus Interface (lane 0 – SDA / SCL)		
sda_i	Input	Serial Data in, from the SDA pad
sda_o	Output	Serial Data out (push-pull data)
sda_o_en	Output	SDA open-drain drive-low enable, active low: 0 = pull SDA low
sda_o_en_active_drv	Output	SDA push-pull enable, active high: 1 = actively drive sda_o; 0 = open-drain / release
scl_i	Input	Serial Clock in, from the SCL pad
scl_o_en	Output	SCL line state / drive-low enable, active low: 0 = pull SCL low, 1 = SCL high
scl_o_en_active_drv	Output	SCL push-pull enable, active high: 1 = actively drive SCL high; 0 = release
I3C Multi-Lane Interface – optional, HDR-BT (lanes 1–3)		
sda1i, sda1o, sda1o_en, sda1o_en_active_drv	I / O	Lane 1 data and drive controls, same convention as lane 0. Present when DB_I3C_ML_DUAL or DB_I3C_ML_QUAD is defined (x2 / x4 builds).
sda2i, sda2o, sda2o_en, sda2o_en_active_drv, sda3i, sda3o, sda3o_en, sda3o_en_active_drv	I / O	Lanes 2 and 3 data and drive controls. Present when DB_I3C_ML_QUAD is defined (x4 builds). Lanes carry HDR-BT data and CRC blocks only and are push-pull; the default x1 build has the legacy pin list with no lane pins.

Table 1: DB-I3C-BASIC-M-APB – I/O Pin Description

Verification Method

The DB-I3C-BASIC-M-APB IP Core is delivered with a verification test suite containing AMBA bus functional models that program the control & status registers, generate and send I3C messages, monitor the I3C bus protocol and timing, and check expected results. The passive bus monitor independently re-decodes SDR, HDR-DDR and HDR-BT traffic (including the multi-lane striping) and re-computes parity, CRC-5, CRC-16 and CRC-32 as a second opinion on every frame; a fault-injection model corrupts selected bits to exercise the error paths.

The regression comprises 76 self-checking tests – directed SDR, 31 MIPI I3C CTS v1.2 tests, bridge, and HDR-DDR / HDR-BT – run on both the APB and the AXI4-Lite deliverables, plus 3 additional Multi-Lane tests in the x2 and x4 builds (79 tests). All tests pass in every configuration.

The Controller is verified against the Digital Blocks I3C Target IP, a third-party open-source I3C target model, and the MIPI CTS exerciser model on a wired-AND bus model with contention checking.

Customer Evaluation

Digital Blocks offers a variety of methods for prospective customers to evaluate the DB-I3C-BASIC-M-APB. Please contact Digital Blocks for additional information.

Deliverables

The DB-I3C-BASIC-M-APB is available in synthesizable RTL SystemVerilog or a technology-specific netlist for FPGAs, along with Synopsys Design Constraints, a simulation test bench with expected results, datasheet, and user

manual (Technical Reference Manual with the I3C Basic v1.2 HDR addendum). The same RTL tree delivers the APB and AXI4-Lite bus interfaces and the Controller-only, Target-only and dual-role configurations.

Ordering Information

Please contact Digital Blocks for additional technical, pricing, evaluation, and support information.

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